

STD830CP40

Complementary transistor pair in a single package

Datasheet — production data

Features

- Low V_{CE(sat)}
- Simplified circuit design
- Reduced component count
- Low spread of dynamic parameters

Application

■ Compact fluorescent lamp (CFL) 220 V mains

Description

The STD830CP40 is a hybrid complementary pair of power bipolar transistors manufactured by using the high voltage multi-epitaxial planar technology for high switching speeds and medium voltage capability.

The STD830CP40 is housed in dual island DIP-8 package with separated terminals for higher assembly flexibility, specifically recommended to be used in a new solution for compact fluorescent lamp (CFL).

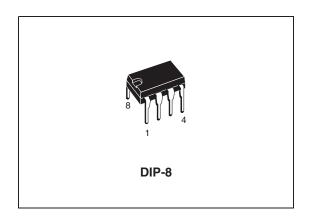


Figure 1. Internal schematic diagram

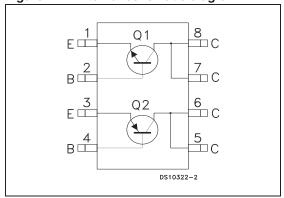


Table 1. Device summary

| Order code | Marking | Package | Packing |
|------------|----------|---------|---------|
| STD830CP40 | D830CP40 | DIP-8 | Tube |

Electrical ratings STD830CP40

1 Electrical ratings

Table 2. Absolute maximum ratings

| Cumbal | Dougrantou | Value | | 11-4 | |
|------------------|--|----------------------|------------|------|--|
| Symbol | Parameter | NPN | PNP | Unit | |
| V _{CBO} | Collector-base voltage (I _E = 0) | | 500 | V | |
| V _{CEO} | Collector-emitter voltage (I _B = 0) 400 | | 00 | V | |
| V _{EBO} | Emitter-base voltage ($I_C = 0$, $I_B = 1.5$ A, $t_p < 10$ ms) | V _{(BR)EBO} | | V | |
| I _C | Collector current 3 | | 3 | Α | |
| I _{CM} | Collector peak current (t _P < 5 ms) | 6 | | Α | |
| Ι _Β | Base current | 1.5 | | Α | |
| I _{BM} | Base peak current (t _P < 1 ms) | 3 | | Α | |
| P _{TOT} | Total dissipation at T _{amb} = 25 °C single transistor | | 3 | | |
| P _{TOT} | Total dissipation at T _{case} = 25 °C single transistor | | 45 | | |
| T _{STG} | Storage temperature | | -65 to 150 | | |
| T _J | Max. operating junction temperature | | 150 | | |

Table 3. Thermal data

| | Symbol | Parameter | Value | Unit |
|---|----------------------------------|---|-------|------|
| ſ | R _{thJA} (1) | Thermal resistance junction-ambient (single transistor) | 42 | °C/W |
| | R _{thJC} ⁽¹⁾ | Thermal resistance junction-case (single transistor) | 2.7 | °C/W |

^{1.} When mounted on 25mm square pad of 2 oz. copper, $t \le 10$ sec.

Note: For PNP types voltage and current values are negative

2 Electrical characteristics

 T_{case} = 25 °C unless otherwise specified.

Table 4. Electrical characteristics

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--------------------------------------|---|---|----------------|-------------------|------------|----------------|
| I _{CES} | Collector cut-off current (V _{BE} = 0) | For NPN: V _{CE} = 700 V V _{CE} = 700 V T _C = 1 For PNP: | 25°C | | 0.1 0.5 | mA mA |
| | | $V_{CE} = 500 \text{ V}$ $V_{CE} = 500 \text{ V}$ $T_{C} = 1$ | 25°C | | 0.1 0.5 | mA mA |
| V _{(BR)EBO} | Emitter-base breakdown voltage (I _C = 0) | I _E = 10 mA For NPN: For PNP: | 10 5 | | 18 10 | V V |
| V _{CEO(sus)} ⁽¹⁾ | Collector-emitter sustaining voltage (I _B = 0) | I _C = 5 mA | 400 | | | V |
| V _{CE(sat)} ⁽¹⁾ | Collector-emitter saturation voltage | ~ | 0.1 A 0.2 A | | 0.5 0.5 | V V |
| V _{BE(sat)} ⁽¹⁾ | Base-emitter saturation voltage | | 0.1 A 0.2 A | | 1.1 1.2 | V V |
| h _{FE} ⁽¹⁾ | DC current gain | $\begin{split} I_{\text{C}} &= 10 \text{ mA} & V_{\text{CE}} \\ I_{\text{C}} &= 0.7 \text{ A} & V_{\text{CE}} \\ I_{\text{C}} &= 2 \text{ A} & V_{\text{CE}} \end{split}$ | | | 34 | |
| t _r t _s | Resistive load Rise time Storage time Fall time | $I_C = 0.7 \text{ A}$ $V_{CC} = 2$ $I_{B1} = 0.14 \text{ A}$ $I_{B2} = -0$ $I_p = 30 \mu\text{s}$ | | 100 2.4 100 | | ns µs ns |
| t _s | Inductive load Storage time Fall time | $\begin{split} I_{C} &= 1 \text{ A} & I_{B1} = \\ V_{BE(off)} &= -5 \text{ V} & R_{BE} \\ V_{clamp} &= 200 \text{ V} & L = \end{split}$ | | 450 100 | | ns ns |

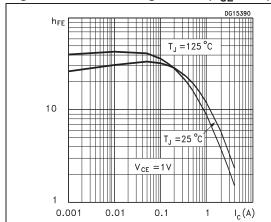
^{1.} Pulse test: pulse duration ≤300 µs, duty cycle ≤2 %.

Note: For PNP types voltage and current values are negative

Electrical characteristics STD830CP40

2.1 Electrical characteristics (curves)

Figure 2. DC current gain NPN ($V_{CE} = 5 \text{ V}$) Figure 3. DC current gain PNP ($V_{CE} = -5 \text{ V}$)



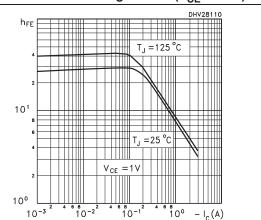


Figure 4. DC current gain NPN ($V_{CE} = 1 \text{ V}$) Figure

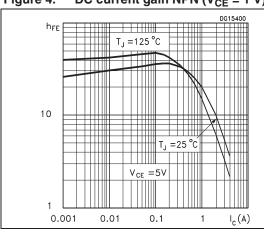


Figure 5. DC current gain PNP ($V_{CE} = -1 \text{ V}$)

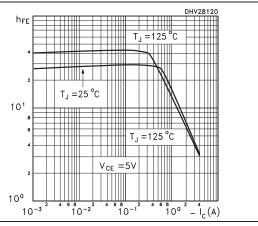
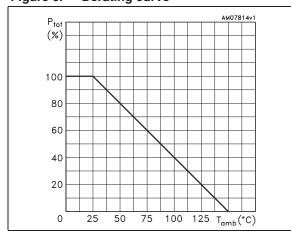


Figure 6. Derating curve



-V_{CE (sat)} h_{FE} =5 10¹ $T_J = 125$ °C $T_J = 125$ 10° 0.1 $T_J = 25$ °C $T_J^{'}=125$ °C 10 0.01 10^{-2} 10-22 $10^{-\frac{2}{3}}$ 10⁻¹ 0.001 0.01 0.1 10° - Ic (A) 1_C (A) 1

Collector emitter saturation voltage Figure 8. Collector emitter saturation voltage Figure 7.

Figure 9. Base emitter saturation voltage NPN

Figure 10. Base emitter saturation voltage **PNP**

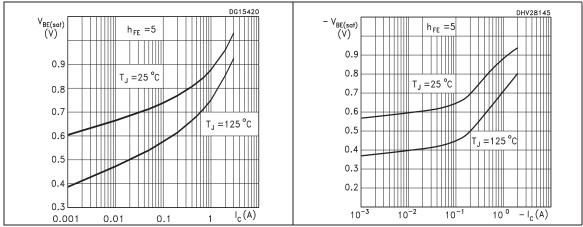


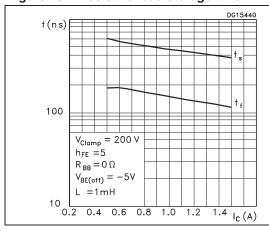
Figure 11. Resistive load fall time NPN

Figure 12. Resistive load fall time PNP t (n s) t (n s) †_s t_s 1000 1000 †_f †_f 100 100 $V_{Clamp} = 250 V$ $V_{Clamp} = 250 V$ $h_{FE} = 5$ $h_{FE} = 5$ $I_{bon} = - I_{boff}$ $I_{bon} = - I_{boff}$ $V_{BE(off)} = -5V$ $V_{BE(off)} = 5V$ 10 10 0.5 0.7 0.5 0.9 1.3 I_c(A) 0.7 0.9 1.3 - I_C (A)

Electrical characteristics STD830CP40

Figure 13. Resistive load storage time NPN F

Figure 14. Resistive load storage time PNP



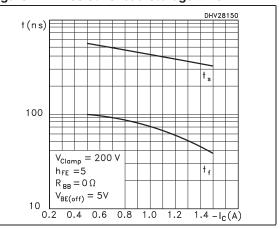
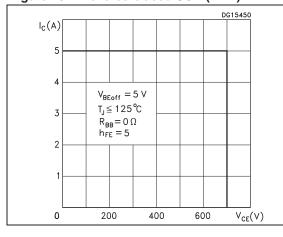
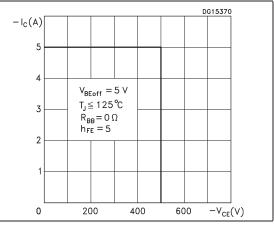


Figure 15. Reverse biased SOA (NPN)

Figure 16. Reverse biased SOA (PNP)





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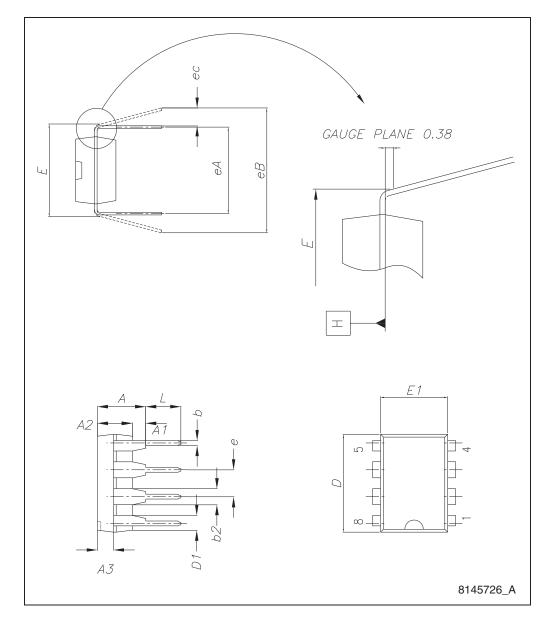
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 5. DIP-8 mechanical data

| Dim | | mm. | |
|------|------|------|-------|
| Dim. | Min. | Тур. | Max. |
| А | | | 4.80 |
| A1 | 0.50 | | |
| A2 | 3.10 | | 3.50 |
| A3 | 1.40 | | 1.60 |
| b | 0.38 | | 0.55 |
| b1 | 0.38 | | 0.51 |
| b2 | 1.47 | | 1.57 |
| b3 | 0.89 | | 1.09 |
| С | 0.21 | | 0.35 |
| c1 | 0.20 | | 0.30 |
| D | 9.10 | | 9.30 |
| D1 | 0.13 | | |
| Е | 7.62 | | 8.25 |
| E1 | 6.25 | | 6.45 |
| е | | 2.54 | |
| eA | | 7.62 | |
| eB | 7.62 | | 10.90 |
| eC | 0 | | 1.52 |
| L | 2.92 | | 3.81 |

Figure 17. Drawing dimension DIP-8



STD830CP40 Revision history

4 Revision history

Table 6. Document revision history

| Date | Revision | Changes |
|-------------|----------|---|
| 27-May-2009 | 1 | Initial release. |
| 29-Jun-2010 | 2 | Modified: Table 2 and Table 3 on page 2, added Section 2.1: Electrical characteristics (curves). |
| 05-Oct-2012 | 3 | Table 2 and Table 3 on page 2 have been modified. |

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